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A new family of Graphene based organic semiconductors: An investigation of photon induced electronic structure manipulation in half-fluorinated graphene.

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Abstract

The application of graphene to electronic and optoelectronic devices is limited by the absence of reliable semi-conducting variants of this material. A promising candidate in this respect is graphene oxide, with a band gap on the order of ~ 5 eV, however this has a finite density of states at the Fermi level. Here we examine the electronic strucutre of three variants of half fluorianted carbon on Sic(0001), i.e. the $(6\sqrt{3} \times 6\sqrt{3})$ R30° C/SiC "buffer layer", graphene on this $(6\sqrt{3} \times 6\sqrt{3})$ R30° C/SiC buffer layer and Graphene decoupled from the SiC substrate by hydrogen intercalation. Using angle-resolved photoemission, core level photoemission and X-ray absorption, we show that the electronic, chemical and physical structure of all three variants is remarkably similar; exhibiting a large band gap and a vanishing density of states at the Fermi level. These results are explained in terms of first principles calculations. This material thus appears very suitable for applications, even more so since it is prepared on a processing- friendly substrate. We also investigate two separate UV photon induced modifications of the electronic structure that transform the insulating samples (6.2 eV band gap) into semi-conducting (~ 2.5 eV band gap) and metallic regions, respectively.

I. INTRODUCTION

The unusual electronic properties of graphene have attracted an enormous interest within the last few years.^{1–6}. Faraday rotation in graphene⁷, graphene based electronics^{1,8,9} and graphene terahertz plasmon oscillator¹⁰ research has provided a basis for the application of graphene but despite all this research organic molecular films still provide the best candidates for carbon based electronics^{11–13}.

Many efforts have been directed at introducing a band gap in graphene, to render it semiconducting, for example by varying the amount of oxidation¹⁴ in a graphene sheet which has lead to a system with a \sim 5 eV band gap but this material has a finite density of states at the Fermi level, making it less desirable for electronic applications.

Recently we showed that the combination of electronic structure exhibited in organic films^{11–13}, including a vanishing density of states at the Fermi level, the benefits of large defect free films, as observed for graphene on SiC, the ability to pattern using UV/ X–ray photons and the ability to produce samples in an industrially friendly manner was observed in half fluorinated graphene on hydrogen terminated SiC¹⁵. In the present paper we extend this research, showing that the choice of substrate–film interface has little effect on the electronic structure of such films. We take a closer look at the UV photon induced modification process, an essential property allowing for patterning of the π bands (~ 2.5 eV band gap) on a semi–insulating (~ 6.3 eV band gap) substrate. In addition we investigate the second, independent, UV photon induced variation which allows for patterning of metallic regions on the same sample. As common lithographic processes can pattern at the nanometer scale using UV photons, devices consisting of nanometer size semi–insulating (~ 6.2 eV), semi–conducting (~ 2.5 eV) and metallic regions are thus possible.

Our earlier study of half–fluorinated graphene sheets presented in the previous work¹⁵ demonstrated that all desirable properties are realized in this new material: (i) the films have a 2.5 eV band gap and readily emit visible light in the blue region on mild heating; (ii) photon induced sample charging is observed, indicating a vanishing density of states at the Fermi level; (iii) graphene produced on the SiC(0001) face has a demonstrated high quality and is ideally suited to industrial production^{16–18} while the fluorination process is also easily transferred to industrial scale; (iv) the conduction and valence bands are susceptible to UV light making standard lithography patterning techniques possible. All of these properties indicate the potential of this new functionalization of graphene and all three of the substrate–film interfaces investigated in the present



FIG. 1. A perspective view of the structure of the top layer of all three samples (A) and a side view of the half fluorinated $6\sqrt{3}C$ –SiC (B), half fluorinated G/ H–SiC (C) and the half fluorinated G/ $6\sqrt{3}C$ –SiC (D). Fluorine atoms are shown in yellow, hydrogen in pink, carbon in grey and silicon in blue.

work share these properties. In addition the marked similarity of other functionalized graphene samples (notable G–O¹⁴ and G–H^{19,20}) provides strong evidence that future G₂ –X, X being any attached atomic species, systems will help to strongly vary the band gap in the semi–insulating and semi–conducting regions providing a strong candidate for the realization of graphene based electronics. In fact theoretical studies have concluded that half hydrogenation of graphene should allow for the conduction and valence bands, similar to those observed in the current samples, to be spin polarized^{19,20} opening the door to integrated spintronic devices.

We present core level X-ray Photoemission spectra (XPS), Angle Resolved Photoemmission spectra (ARPES), Near Edge X-ray Absorption Fine Structure spectra (NEXAFS) and Resonant photoemission spectra (ResPES) on half fluorinated Quasi freestanding graphene, graphene on $(6\sqrt{3} \times 6\sqrt{3})$ R30° C and $(6\sqrt{3} \times 6\sqrt{3})$ R30° C samples on silicon terminated SiC(0001) sub-

strates. The carbon atoms in graphene are sp² bonded in a 2D hexagonal lattice, so called σ bonds. The p-orbitals perpendicular to the plane form a delocalised π bonding network, known as π bonds. In fully functionalized graphene each alternating carbon atom has the, formerly, π bonds above (below) the plane respectively, attaching hydrogen^{21,22} or fluorine^{19,20,23} to each of these bonds results in a semi-conducting material with a band gap of ≥ 3 eV. However attaching fluorine to one side only results in the formation of two flat, localized, bonding/ antibonding states above and below the Fermi level, respectively after extreme ultra violet (EUV) photon irradiation. Although this results in both the σ and π bands obtaining a strong sp3 character, for ease of description we will continue to call the electronic bands resulting from these bonding atoms as σ and π "states", this is done mainly because the formerly σ bands in the graphene structure are relatively unchanged on half functionalization, while the formerly π bands are strongly influenced. The two flat, localized, states are similar to the HOMO and LUMO levels in organic electronic materials¹¹⁻¹³. This was attributed to transitions between a ground state configuration and a metastable configuration resulting in defect states. We show that the film-substrate interface has little effect on the electronic structure and investigate two separate EUV photon induced modifications that transform the semi-insulating samples (~ 6.3 eV band gap) into semi-conducting (~ 2.5 eV band gap) and metallic regions, respectively. These new samples are therefore perfectly suited for implementation in graphene based electronic devices.

II. METHODS

Experiments were performed on quasi-freestanding graphene, graphene on $(6\sqrt{3} \times 6\sqrt{3}) \text{ R30}^{\circ}$ C and $(6\sqrt{3} \times 6\sqrt{3}) \text{ R30}^{\circ}$ C samples on silicon terminated SiC(0001) substrates. The $(6\sqrt{3} \times 6\sqrt{3})$ R30° C layer (hence forth $6\sqrt{3}$ C) layer is a covalently bound, electrically inactive graphene layer²⁴ in which about one third of the C atoms bind to the Si atoms on the SiC(0001) substrate. This bonding breaks up the π band network so that the $6\sqrt{3}$ C layer has no Dirac cone. The $6\sqrt{3}$ C/SiC samples were prepared with the method of Emtsev et al.²⁴ which involves annealing of SiC in an Ar atmosphere. The graphene on $6\sqrt{3}$ C/SiC (hence forth G/ $6\sqrt{3}$ C–SiC) was prepared in the same method, with a higher annealing temperature²⁴. Quasi-freestanding graphene (hence forth G/ H–SiC) was prepared from a $6\sqrt{3}$ C/SiC sample by the method of Riedl et al.²⁵ where annealing in a hydrogen atmosphere intercalates hydrogen between the $6\sqrt{3}$ C layer and the substrate, decoupling the carbon layer producing quasi-freestanding graphene films. Samples were fluorinated following a method similar to that of McFeely et al.²⁶ whereby samples are placed in a reaction chamber with a XeF₂ crystal and heated to 200 °C for 2 hours, leading to the dissociation of the XeF₂ and the liberation of reactive fluorine atoms. This method has previously been used to study the interaction between fluorine and silicon surfaces²⁶ as well as fluorine and graphene^{23,27–29} and leads to the formation of C–F bonds with the graphene layer. After annealing the $6\sqrt{3}$ C–SiC, G/ $6\sqrt{3}$ C–SiC and G/H–SiC samples will be labeled as F– $6\sqrt{3}$ C/SiC, F–G– $6\sqrt{3}$ C/SiC and F–G/H–SiC respectively

ARPES, NEXAFS, XPS and ResPES spectra were obtained at the Electronic Structure Factory endstation (SES–R4000 analyzer) at beamline 7 of the Advanced Light Source, Lawrence Berkeley National Laboratory. The spatial area sampled in these measurements was typically 50 to 100 μ m. During the measurements the samples were cooled to ~ 100 K using a liquid He–cooled cryostat and the pressure was < 2 × 10⁻¹⁰ Torr. A photon energy of 95 eV was used in the ARPES measurements giving overall resolutions of ~ 25 meV and ~ 0.01Å⁻¹.

First-principles calculations were performed using the VASP code^{30,31}. The projector augmented wave (PAW) method^{32,33} and the generalized gradient approximation of Perdew-Burke-Ernzerhof³⁴ (GGA-PBE) are adopted. The Energy cutoff is set to 400 eV and the k-grid mesh is $9 \times 9 \times 1$. Structural relaxation was stopped when the force acting on each atom was less than 0.01 eV/Å. Van der Waals interaction were included by using the DFT-D2 approach.³⁵ The vacuum layer was larger than 10 Å to avoid interaction between periodic images. Dipole correction is applied to eliminate the effect of artificial electronic field imposed by the periodic boundary condition. In the calculations, the SiC substrate contains four SiC layers, and the two bottom layers were kept fixed. The dangling bonds at the bottom surface are passivated by H atoms. The work function is determined as the energy difference between the Fermi level and the vacuum level at the half-fluorinated graphene side. Charge transfer is calculated based on the Bader charge analysis.³⁶

III. RESULTS

A. Physical and Chemical Structure

The structure of the F–G/H–SiC sample has been shown to consist of fluorine attached to one side of the graphene layer¹⁵; A schematic is shown in Fig. 1A. The existence of similar dangling



● F-6√3 C/SiC ● F-G-6√3 C/SiC ● F-G/ H-SiC

FIG. 2. XPS spectra obtained from the three samples: $F-6\sqrt{3}$ C/SiC (black circles), $F-G-6\sqrt{3}$ C/SiC (red circles) and F-G/H-SiC (blue circles). Overview scans (not shown) indicate only C, F and Si present in the samples except for a small (< 2%) O contamination. Detailed F 1s (A), C 1s (B) and Si 2p (C) are also shown, with fitted peaks (solid coloured lines) and fitted spectra (solid green lines).

bond states, as revelaed in ARPES data (below), in the F– $6\sqrt{3}$ C/SiC and F–G– $6\sqrt{3}$ C/SiC samples suggests a similar fluorinated structure. The side view of the F–G/H–SiC sample is presented in Fig. 1C, where the H terminates the SiC dangling bonds and the resulting C₂F film is decoupled from the substrate. A similar structure is proposed for the F– $6\sqrt{3}$ C/SiC structure (Fig. 1B), although the Si dangling bonds remain. Complete fluorination of bilayer graphene has been theoretically shown to result in sp³ bonding between the two graphene layers³⁸ forming a C₄F film, we therefore propose a similar structure for the F– $6\sqrt{3}$ C/SiC sample, shown in Fig. 1D.

The extent of bonding between the two types of films in Fig. 1 B and D and the substrate is investigated using XPS. All three samples are observed to emit blue light, after exposure to UV photons and subsequent light annealing, as a result we conclude that the ground state configuration and metastable configuration observed previously¹⁵ are attributed to all three. In addition all three have a photon induced C1s component ($G_{F(c)}$ in Fig. 2) which is observed after exposure to UV photons. This was previously shown¹⁵ to be related to the metastable state, and provides further evidence of a similar ground and metastable state in all three samples.

TABLE I. XPS fitted peak positions (eV) for the three samples investigated before and after fluorination. The C 1s peaks in the fluorinated samples are assigned, in agreement with the structures in Fig. 1, as: G_{Ca} –C bonded to C, G_{Ca} –C bonded to C close to the substrate (F–G– $6\sqrt{3}$ C/SiC only), $G_{F(a/b)}$ –C bonded to F in the ground configuration, $G_{F(c)}$ –C bonded to F in the metastable configuration, G_S C bonded to the substrate.*Note: For the un-fluorinated samples G_{Cb} is the buffer layer C–C bonded component, G_{Fa} is the graphene component and G_S is the C bonded to the substrate component.

energy (eV)	F 1s	C 1s						Si2s	Si2p	
Sample		$\mathrm{G}_{\mathrm{S}}^{*}$	$G^{\ast}_{\rm Cb}$	$G^*_{\rm F(a/b)}$	$G_{\rm Ca}$	SiC	$G_{\rm Fc}$		S1	S0
$6\sqrt{3}$ C–SiC	n/a	-284.75 ²⁴	-285.55 ²⁴	n/a	n/a	-283.7 ²⁴	n/a	-152.5^{25}	101.7 ³⁷	-101.4 ³⁷
$F-6\sqrt{3}$ C/SiC	-686.5	-286.34	n/a	-285.70/284.9	8–284.49	-283.7	-284.71	-152.5	-101.6	-101.3
$G/6\sqrt{3}$ C–SiC	n/a	-284.75 ²⁴	-285.55 ²⁴	-284.75 ¹⁸	n/a	-283.7 ²⁴	n/a	-152.5^{25}	-101.7 ³⁷	-101.4 ³⁷
F–G– $6\sqrt{3}$ C/SiC	-686.5	-286.40	-285.13	-285.72/284.9	6–284.51	-283.7	-284.72	-152.5	-101.6	-101.3
G/H–SiC	n/a	n/a	n/a	-284.6 ²⁵	n/a	-283.0^{25}	n/a	-151.8^{25}	-100.9^{25}	-100.6^{25}
F–G/H–SiC	-685.5	n/a	n/a	-284.99/284.2	3–283.27	-283.7	-283.40	-152.5	-101.6	-101.3

An overview XPS spectra was obtained from each of the three samples (not shown) which indicates only that F, C and Si are present, except for a small (< 2 %) oxygen contamination. Detailed XPS spectra from the three samples are presented in Fig. 2 with least squares fitted components also included. In addition the fitted component peak positions are listed in Table I along with the positions of the peaks prior to fluorination. To provide a greater insight, we include in Table II the calculated work function (WF) and the calculated charge transfer between the various layers for comparison to the XPS spectra. The F 1s peaks consist of only one component in all 3 cases, indicating that a single chemical species is present consistent with the structures proposed in Fig. 1. The only difference in the F peak is a shift of $\sim 1 \text{ eV}$ to lower binding energy for the F-G/H-SiC sample. This is consistent with an increase in the calculated work function of this sample by $\sim 1 \text{ eV}$ compared to the two others. The Si 2p peak has two doublet peaks (labeled S0, bulk component, and S1, surface component) as described by Carlisle et al³⁹, the adatom component (S2) is not present due to the lack of adatoms on the surface after graphene growth. The Si 2p peaks are similar for all 3 samples, and similar to the un-fluorinated $6\sqrt{3}$ C–SiC and G/6 $\sqrt{3}$ C–SiC. The relative shift of the un-fluorinated G/ H–SiC (of ~ 0.7 eV) may indicate that the H layer is removed during the fluorination process. However, this would lead to a sample

TABLE II. Table showing the work function and charge transfer between the substrate and the F-G layers for each of the substrates calculated by DFT as explained in the methods section. The amount of the additional (donated) electron is shown by minus (plus) sign.

energy (eV)	WF	ChargeTransfer				
Sample		F	1st	C 2nd	C substrate	
		layer	layer	layer		
$F-6\sqrt{3}$ C/SiC	7.21	+0.1	+1.7	n/a	-1.8	
$F-G-6\sqrt{3}$	7.27	+0.2	-0.1	+1.5	-1.6	
C/SiC						
FG/H-SiC	8.36	0	0	n/a	0	

indistinguishable from the F– $6\sqrt{3}$ C/SiC, which does not agree with the F 1s and the C 1s peaks (discussed below). Our calculations indicate that, similar to the G/H–SiC case, no charge transfer is likely to occur between the H–SiC substrate and the F–G layer. We propose, however, that the Si 2p XPS data indicates that for F–G/H–SiC charge transfer between the substrate and the F–G film does occur.

Let us now turn to a detailed analysis of the C1s peak shape. The C1s peak has components: from the substrate (SiC), for C –C bonded species (G_{Ca}), C –C bonded species close to the SiC substrate (G_{Cb}), C bonded to F in the ground configuration ((G_{Fa}) and (G_{Fb})), C bonded to the SiC substrate ((G_S)) and a photon derived C species ((G_{Fc})) which is attributed to the C bonded to F in the metastable configuration. The location of each of the atomic species is indicated in Fig. 1 while the atomic ratios of each component are presented in Table III. Interestingly it appears that the fluorination process reduces the number of graphene–substrate bonds for the F– $6\sqrt{3}$ C/SiC and the F–G– $6\sqrt{3}$ C/SiC samples, as only 4% of the C atoms (Table III, (G_S) peak) are now bonded to the substrate (~ 33 % and ~ 16% originally). This indicates a reduction in the substrate– film interaction upon fluorination.

It is perhaps important to note here that the XPS fitting was performed without considering the number of "expected" components and the number of peaks is the minimum number that provided a good description of the measured data. During the fitting all parameters of all peaks (energy, amplitude, Lorentzian width, Gaussian width, Asymmetry) where "free". The results of the fitting therefore indicate that the calculated structures shown in Fig. 1 are not entirely accurate, in fact

the F atoms not being centered directly over the C atoms below (see Fig. 1) perhaps leads to a slight buckling, or a slight increase/decrease, of each alternating F bonded C atom resulting in 2 independent C-F bonded components in the ground state. As only one F component is observed, this suggests that the high charge associated with the F atom results in a much smaller (and unobservable in the current data) shift in the F atoms.

In the F–G – $6\sqrt{3}$ C/SiC there are two Gfb components instead of one in the F– $6\sqrt{3}$ C/SiC. This is due to presence of the extra graphene-like layer underneath (buffer layer). This component is at the same binding energy (Table I) as before fluorination, while the other C1s components are the same as those observed in the F– $6\sqrt{3}$ C/SiC sample. This is in direct contrast to the calculated chemical shifts, which give a shift of ~ 1.8 eV between the locations of the C peaks in the top most layer in these two samples. The similarity of these top layer carbon line-shape components in the two samples indicates that the F atoms play the major role in these chemical shifts and not the substrate as indicated by the calculated charge transfers. A further indication of the role of the F atoms is found by considering the experimental atomic ratio, 2% of the graphene atoms (4% of the bottom layer) are now bonded to the substrate, similar to the case of F– $6\sqrt{3}$ C/SiC. An important result here is that this mechanism of charge transfer to the substrate acts to maintain the chemical state of the substrate, thereby maintaining the location of the Fermi level in the gap. While such a complicated charge transfer mechanism is not common in normal metal semi–conductor interfaces, equally complex mechanisms have been observed in organic electronic materials^{11,13,40} which are closely related to graphene films.

This same mechanism is derived from the results of the F–G/ H–SiC sample, where the substrate related peaks shift (–0.7 eV) from the clean SiC values⁴¹ by a similar amount to those seen in the previous samples (Table I and Fig. 2). As described above we rule out the removal of the H interface layer and a subsequent resumption of the graphene–substrate bonding due to the complete lack of a substrate bonding component in the C 1s (G3) and the significant differences between the C1s spectra for the F–G/H–SiC and the F– $6\sqrt{3}$ C/SiC samples. Instead we observe a large, 1.4 eV, chemical shift of the G_{Ca} component (closest to the substrate) which we attribute to a charge transfer from the substrate to the F–G film, which is contrary to the results from the calculations. This pronounced shift results in the same chemical state (peak locations) for the SiC substrate as in the previous two samples and therefore is attributed to a Fermi level pinning commonly observed in semi–conductor hetero–junctions⁴². This will be discussed in more detail below in the section regarding electronic structure.

TABLE III. Atomic ratios for the different species, scaled from XPS fitted peak areas using the calculated photoemission cross–sections⁴³, for the three samples after fluorination. The expected values (in brackets and italics) are determined based on the observed $G_{Fa,b,c}/(G_{Ca,b}+G_S)$ ratio, the observed substrate bonding ratio (G_S) and the structures presented in Fig. 1.

	F-G/H-SiC	$F-6\sqrt{3}$ C/SiC	F–G– $6\sqrt{3}$ C/SiC
Atomic conc. (ratios)	obs. (exp.)	obs. (exp.)	obs. (exp.)
F/G peaks	0.28 (0.33)	0.39 (0.37)	0.16 (0.17)
G_{Fa}	0.12 (0.13)	0.09 (0.10)	0.09 (0.07)
G_{Fb}	0.12 (0.13)	0.08 (0.10)	0.08 (0.07)
G_{Fc}	0.11 (0.13)	0.07 (0.09)	0.08 (0.06)
G_{Ca}	0.65 (0.61)	0.72 (0.67)	0.46 (0.49)
G_{Cb}	n/a	n/a	0.26 (0.29)
G _S	n/a	0.04 (0.04)	0.02 (0.02)

The Fluorination of the top most graphene layer is found to be 33%, 38%, and 39% for the F–6 $\sqrt{3}$ C/SiC, F–G–6 $\sqrt{3}$ C/SiC and F–G/H–SiC samples respectively (Table III). This indicates slightly less than half fluorinated samples, however the use of calculated photoemission cross–sections⁴³ is known to introduce large errors. A better approach is to compare the ratio of the C 1s component related to graphene bonded to F (G_{Fa,b,c}) to all other graphene C 1s components as the cross–section in this case is not relevant. Expected atomic ratios based on the area of the fitted peaks and the structures presented in Fig. 1 are compared to experimental values in Table III. Good agreement is seen between the experimental and expected values in all three samples providing strong support for the proposed structures presented in Fig. 1. Further support is given by comparing this to our previous measurements¹⁵, where good agreement to these new sample is found. Structure assignment is strengthened in the previous paper by including photo-electron diffraction data.



FIG. 3. ARPES spectra obtained along the three principle directions for un-fluorinated $6\sqrt{3}$ C–SiC (A), F– $6\sqrt{3}$ C/SiC (B), F–G– $6\sqrt{3}$ C/SiC (C) and F–G/H–SiC (D). As a guide to the eye first nearest neighbor tight binding calculations of graphene σ bands, performed using the parameters given by Saito et al.⁴⁸, are overlaid in A-D with a scaling of 0.8 and an ϵ_{2p} value of -2.4 eV.

The XPS analysis therefore indicates a number of important features of these samples: The fluorination of samples with film-substrate bonding acts to reduce the number of atoms bonding with the substrate, thereby reducing the film-substrate interactions. A complex charge transfer mechanism, similar to that observed in organic films^{11,13,40} acts to keep the substrate peaks at the same position in all samples, despite the change in work function between the F–G/H–SiC sample and the others. Finally the fluorination of G/6 $\sqrt{3}$ C–SiC results in the formation of bonds between the fluorinated graphene layer and the $6\sqrt{3}$ C producing a chemical structure very similar to that of F–6 $\sqrt{3}$ C/SiC. As all three samples appear to have similar physical and chemical structures it



FIG. 4. The band structures of the three different structures. The red dots indicate the contribution from the half-fluorinated graphene.

becomes relevant to ask whether they also have similar electronic structures.

B. Valence electronic structure

The similarity of the physical and chemical structure of the three samples is also apparent in the electronic structure (Fig. 3 B-D) as revealed in angle resolved photoemision of the valence bands. The ARPES data is presented as binding energy versus wave-vector images, with the photoemission intensity indicated by a color scale; the present maps show the photoemission along the major axes in the 2D Brillouin zone of Graphene. For comparison the band structure of the $6\sqrt{3}$ C-SiC structure prior to fluorination is also included (Fig. 3A), which has some differences and some similarities. As discussed in the introduction the hexagonal carbon structure has σ bonds and π bonds, the later projecting out of the film plane. These form two types of valence bands, σ bands and π bands, respectively, with the π bands forming the delocalised, linear Dirac like, bands which are commonly associated with graphene. Bonding between the graphene and a substrate or functional group (H^{19,20}, F^{38,44,45}, O⁴⁶, Si²⁴) acts to destroy the delocalised π bonds, with the remaining non-bonding graphene π electrons forming localized non dispersing energy bands. For the case of $6\sqrt{3}$ C–SiC one third of the graphene C atoms bond to the substrate, quenching the substrate dangling bonds, with the remaining atoms forming the non-dispersing localized bands observed at ~ -1.6 eV and ~ -0.6 eV in Fig. 3A. Buckling of the graphene lattice results in the sp² bonding becoming more sp³ like and this alters the sp and p_z character of the π and σ bands significantly. The band structure calculations, and measurements, indicate that the effect on the



FIG. 5. NEXAFS measurements of the unoccupied states on the F– $6\sqrt{3}$ C/SiC (black), F–G– $6\sqrt{3}$ C/SiC (red) , F–G/ H–SiC (blue) and un-fluorinated G/ H–SiC. The spectra in B has had the polynomial background (black dashed line in A) subtracted from the spectra in A to highlight the peaks. Vertical lines highlight the peaks related to fluorinated graphene (dashed, pink), un-fluorinated graphene (dotted, purple) and substrate (solid, green).

 σ bands is small with little change to these states observed. In contrast the π bands are strongly affected, therefore in order to make the discussion easier to follow we will continue to use the π and σ nomenclature despite this being not strictly true. While some of the non- π bands (those in the range –3 eV < –10 eV in Fig. 3A) are due to the SiC substrate or are due to the semi-bonding π bands in the ground configuration, for ease of discussion unless otherwise stated they will be labeled as σ bands in the following.

The most intense band in the fluorinated graphene samples is the weakly dispersing one observed to cross the Γ , K and M points at about ~ -12 eV and ~ -10 eV (Fig. 3B–D). These two bands are attributed to predominantly F atom states, based on the calculations by Junkermeier et al⁴⁷. A non–dispersing π band is observed in the fluorinated samples at ~ -1.9 eV, however this band only appears after photon irradiation and its intensity is related to that of the peak labeled G_{Fc} in Fig. 2B. The origin of this band will be discussed in detail in the next section, but for now it is important to note that a second non-dispersing band is observed at $\sim 0.6 \text{ eV}$ in the $6\sqrt{3} \text{ C-SiC}$ sample. As no other non-dispersing band is observed in the fluorinated sample we conclude that the band corresponding to the 0.6 eV band in $6\sqrt{3}$ C-SiC band is instead shifted above the Fermi level, a fact that is confirmed by the NEXAFS data presented below.

The rest of the σ bands are similar in the fluorinated samples and the $6\sqrt{3}$ C–SiC sample, further confirming the similarity of the structures. To illustrate this first nearest neighbor tight binding (FNN–TB) calculations of the σ bands performed using the method and parameters of Saito et al.⁴⁸ are overlayed (black dashed curves in Fig. 3). This shows that the graphene σ bands are not substantially altered by fluorination. The calculated π bands are not shown as the half fluorination process changes these significantly.

We can now turn our attention to an apparent contradiction, that is the valence bands of the fluorinated graphene structures have the same binding energy in each of the cases, while the F–G/H–SiC sample has significantly shifted ($\sim 1 \text{eV}$) graphene core levels. In the simple band–bending model of charge transfer a ridged shift of valence and core levels is expected. Differing shifts in the valence and core levels can be explained as follows. The substrate core and valence levels undergo rigid band–bending which aligns the Fermi level in the gap. The valence electrons in the fluorinated graphene layer are shifted via the interactions with the substrate discussed in the previous paragraph. These mechanisms involve screening/ interaction with the substrate electric field and/or valence bands. The fluorinated graphene nuclei will screen the core level electrons from these effects much more strongly than the valence electrons, therefore we can expect relative shifts between the core levels and the valence levels. The final step involves the dipole induced alignment of the gaps in the semi–conducting heterojunctions described by Tersoff⁴² which acts to align the fluorinated graphene valence bands with the SiC valence bands.

For a deeper understanding of the electronic structure of half-fluorinated graphene on three different substrates we also calculated band dispersions, which are presented in Fig. 4. As in the previous investigation¹⁵ the calculations have a similar shape to the observed ARPES spectra (Fig. 3), particularly if we only consider the fluorinated graphene σ bands (in red in Fig. 4). Quantitatively however a large "scaling factor" of ~ 3 is required to match the calculations with the experimental bands. This scaling factor applies to the entire band-structure and not just the band gap. In the following discussion we will restrict ourselves to the fluorinated graphene (red) bands as these appear to be the most visible bands in the ARPES spectra. The F–6 $\sqrt{3}$ C/SiC and the F–G–6 $\sqrt{3}$ C/SiC calculations are particularly similar, as is observed experimentally. The main

difference is a new flat band appearing at the Fermi level in the F– $6\sqrt{3}$ C/SiC case, which is not observed in the ground state spectra experimentally, recalling that the flat band at ~ 2 eV in Fig. 3 only appears after photon irradiation. Instead we observe something similar for the F–G– $6\sqrt{3}$ C/SiC calculations in both cases. This we attribute to the calculations not correctly predicting the bonding between the F– $6\sqrt{3}$ C and the SiC substrate, indicated by the XPS spectra. This is most likely a result of the incomplete fluorination and the small substrate-sample bonding observed in the experimental samples that breaks up the π bonding network and is the origin of this flat band. The final structure, F–G / H–SiC also has a similar calculated spectra, however it is shifted ~ 1.4 eV closer to the Fermi level. As described above we believe that a core level screening process shifts the valence band relative to the core-levels in this case, placing the Fermi level in the gap of the F–G. This results in a similar positioning of the bands for all three substrates investigated.

An important test of the current description of the occupied electronic structure in systems which have one graphene sub–lattice sp³ bonded to a functional group is to compare the calculated σ bands of a number of these systems. These σ bands, with their energy maxima at Γ , should be very similar as we only observe major differences in the π bands between the $6\sqrt{3}$ C–SiC sample and the fluorinated samples. While published calculations of half functionalized graphene systems have been limited to hydrogenation^{20,44,49} the study of fully functionalized systems has been much wider. Fully hydrogenated^{21,49}, fluorinated^{44,45} and half hydrogenated–half fluorinated graphene⁴⁴ have all been shown to have very similar electronic structures which are dominated by the σ bands and two sets of bonding π bands. This is confirmed by our own calculations in Fig. 4. All of these calculations of a second set of bonding π bands expected for the fully hydrogenated case and a second set of σ bands and a set of non-bonding π bands in the half hydrogenated case. The second set of σ bands in the half hydrogenated case is due to the loss of sub–lattice symmetry associated with bonding to one sub–lattice only.

In order to investigate the unoccupied states in the fluorinated samples NEXAFS measurements were recorded (Fig. 5) and compared to that for un-fluorinated $G/6\sqrt{3}$ C–SiC. In order to enhance the discussion of the NEXAFS we present a quick description of how ARPES and NEXAFS spectra are connected. ARPES spectra provide the unoccupied band structure, including the energy and momentum. NEXAFS on the other hand measures the un-occupied states providing a momentum-integrated measure of these states. So the first requirement to compare the two is to integrate (or sum) the ARPES data along the momentum axis. We now have a series of peaks at various ener-

gies in both data sets which are related. The intensities of the two measurements, however, are not comparable.

In order to highlight the peaks in the spectra in Fig. 5 A a polynomial background (dashed black line) has been subtracted from each spectra, with the results presented in Fig. 5 B. Each of the observed peaks is then labeled as F–G (only observed in fluorinated samples), G (only observed in the un-fluorianted sample) or SiC (observed in all samples). Comparison of the F–G labeled peaks to the band crossings at Γ in Fig. 3 B–D allows the assignment of the first (lowest energy), second, fourth and fifth NEXAFS states to similar but not identical to the ARPES states (the calculations show that the occupied states have a similar, but not symmetric un-occupied band). NEXAFS is an angle integrating technique, therefore the third NEXAFS peak can be associated with the ARPES band which curves down to cross the K and M points close to the flat band at ~ 10 eV.

Variations in localized states have been extensively studied in organic electronic films^{11,13} with a decrease in separation of the localized π states (hence forth "gap") related to an enhanced screening of the photo-hole via the substrate electric field. An important aspect of this process is that the center of the "gap" between the two localized levels remains constant with energy. A second process, which acts to shift the "gap" center, occurs due to the partial metallization and hybridization of localized orbitals in the organic (graphene) layer and this process can shift the usually unoccupied upper localized state below the Fermi level. In the current investigation it is expected that, due to the $6\sqrt{3}$ C–SiC bonding, the SiC –C film separation distance will be smaller than in the fluorinated samples and hence both of these processes which act on the localized states will have a greater effect. This leads to a much smaller separation of the localized states and a shift of the upper state below the Fermi level in $6\sqrt{3}$ C–SiC. Importantly, in this case the variation of the "gap" size between fluorinated samples and the $6\sqrt{3}$ C–SiC is an order of magnitude larger than observed in any organic film layer. This is most likely due to the large "gap" between the fluorinated localized π bands and the strong $6\sqrt{3}$ C–substrate interactions in the un-fluorinated sample.

We thus arrive at a consistent picture of the chemical, physical and electronic structure of the three fluorinated samples. Each one has fluorine bonded to one sub-lattice of the graphene, which results in σ bands, bonding π bands and non-bonding localized π states. In the ground state these dangling bonds form semi-bonding pairs which act to buckle the films, resulting in every second row of F bonded C atoms being pushed above the plane in the "boat" structure. This pairing also removes the localized dangling bond states. A second, photon induced, metastable

state is also observed which has the localized dangling π band states. Fermi level pinning acts to align the band gaps of the fluorinated graphene and SiC and sets the Fermi level within the gap. Relative shifts in the valence and core levels are attributed to partial core-level screening, similar to what has been observed in organic electronic films. The occupied states have corresponding unoccupied levels and the proposed interpretation is supported by calculations. In addition the same mechanisms can explain the electronic structure of the related $6\sqrt{3}$ C–SiC, where two thirds of one graphene sub–lattice bond to the substrate. The one omission from the current discussion has been the non–dispersing state at ~ –1.9 eV and its unoccupied counterpart at ~ 0.6 eV, as mentioned these are photon induced states and a discussion of the photon induced modifications will complete the understanding of the system.

C. Photon Induced Modifications

In our earlier study¹⁵ of half fluorinated graphene on the H passivated SiC(001) surface we found two seperate photon induced modifications of the electronic band structure. The first occurs upon low intensity irradiation (90 eV photons) with small doses, and induces a transformation from the stable conformation to a meta stable structure that is characterized by the appearance of new emission lines in the valence and core level spectra. This transformation acts to reduce the band gap from ~ 6 eV to ~ 2.5 eV. This metastable phase reverts back to the ground state, under emission of blue light. The second process involves the removal of the fluorine atoms by intense UV irradiation with high doses (zero-order light consisting of a large range of photon energies). This causes exposed regions to revert back to the metallic graphene film. Both of these mechanisms are important, the first allows for regions of small band gap semi–conductor to be patterned, while the second allows for regions of un-fluorinated graphene or $6\sqrt{3}$ C to be patterned. Both of these processes appear to produce regions which are limited in size by the photon spot, which means that the application of standard lithography techniques should be able to pattern the regions at the nanometer scale.

The investigation of the low intensity photon variation using photon based techniques required a complicated measurement procedure. Spectra where obtained over the C1s edge using very low flux and very short exposure times (millisecond range), to slow the photon induced modifications, by measuring the valence band as a function of photon energy in 0.01 eV steps between 282 eV and 294 eV. Several spectra were then obtained sequentially with the beam blocked from hitting the sample between measurements. In this way we were able to obtain valence band spectra as a function of photon exposure time. Concurrently with the acquisition of the valence band photoemission spectra at each photon energy the current to ground was recorded, which gives the NEXAFS spectra also as a function of exposure time.

In addition to the occupied bands from the ARPES spectra, and the unoccupied spectra from the NEXAFS at the same time we can obtain the 2nd order core level, which corresponds to an XPS spectra of the C1s core level taken with 2nd order photons (photons with twice the energy of the photon energy scale). By looking at this feature when it lies above the Fermi level, and fitting the component peaks shown in Fig. 2 B, we can determine the variation in chemical structure with photon irradiation time. The position of the G_{Ca} XPS peak was use to provide the "zero" for the photon energy axis of the NEXAFS spectra in the conversion to initial state energy. Calibration of the Fermi level is done by looking for the crossing of the low photon auger emission edge and the second order core level. The actual resonant photoemission features (red dashed lines) are also shown but where not used in the current analysis. This approach allows us then to investigate the chemical variations (2nd order core level), occupied states (angle integrated photoemission) and unoccupied states (NEXAFS) as a function of photon irradiation time in a single measurement.

1. Low intensity irradiation

The results of the low intensity photon irradiation measurements performed in a F–G/ H–SiC sample are shown in Fig. 6 and are representative of those obtained on the other substrates. Angle integrated photoemission and NEXAFS measurements are presented in Fig. 6 A and B from before (dashed lines) and after (solid lines) irradiation. Component peaks, based on the location of the assigned peaks in Fig. 5, were fitted to both the occupied and unoccupied states at each of the four irradiation time intervals obtained. An example of the fitting is shown for the spectra after irradiation in Fig. 6 A and B, with the fluorinated graphene σ /bonding π (solid black), F derived (purple) and localized dangling π bond (red) components highlighted. No variation of the fitted amplitude of the dashed component peaks in Fig. 6 A and B was observed, while the fluorinated graphene component peak variation is shown in Fig. 6 C and D for the occupied and unoccupied states respectively. The localized contributions from states (F–G 1) show an increase with photon exposure, indicating the generation of localized π states. This transition also results in a slight geometrical shift of the F atom bonding orbitals, and leads to the observed reduction in the F–G4



FIG. 6. The occupied (A) and unoccupied (B) states of the fluorinated G/ H–SiC before, dashed blue/grey lines, and after, solid blue/grey lines, photon irradiation measured using angle integrated photoemission and NEXAFS respectively. A fit to the after irradiation spectra (dashed, black) and the corresponding peaks (dotted/dashed, black) are shown, with the peaks corresponding to the fluorinated graphene highlighted in solid black(C derived), purple (F derived) and red, (localized dangling π bond) lines). The variation of the peak amplitude with photon irradiation time for the occupied and unoccupied spectra, for the peaks labeled in A and B, is presented in C and D, respectively. A similar plot for the amplitude of the peaks in the 2nd order C1s spectra, extracted from the same resonant photoemission data, is presented in E with the peaks labeled as in Fig. 2 C.

and F–G5 components (Fig. 6 D and E). The XPS as a function of photon irradiation time also shows an increase in the photon induced (G_S) component and a corresponding decrease in the non–fluorine bonded C atom components (G_{Ca} and G_{Cb}).

This low intensity photon variation is technologically important, as it allows for the patterning of semi-conducting regions (those exposed to low intensity photons) with a band gap of ~ 2.5 eV onto a more insulating sample which has a band gap of ~ 6.2 eV. As the photon irradiated



FIG. 7. The C1s spectra stack plot (A) and intensity plot (B), as a function of sample position, across two regions (position ~ -0.5 mm and ~ 7 mm) of a F $-6\sqrt{3}$ C/SiC sample that have been exposed to high photon radiation doses over several hours. The corresponding amplitude of the F 1s peak is shown in C. The inset to A contains an example C1s spectra (solid, red) from the fluorine depleted regions (red spectra in A) with the standard fit²⁴ (dashed, black) consisting of two $6\sqrt{3}$ C peaks (solid, grey) and a substrate peak (dotted grey).

regions emit blue light under mild heating this may pave the way to integrated opto-electronics devices. After irradiation the photon induced π bands are stable for at least several months but annealing causes a transition back to the ground state. While the fluorinated graphene structures are stable in air, the low intensity induced photon variations are not. We conclude then that low intensity photon irradiation imparts enough energy into the fluorinated graphene film to raise the system from the ground state to a metastable fluorinated graphene layer which relaxes back to the ground state by annealing or exposure to air. Another important aspect of device manufacture is the ability to pattern metallic regions onto a semi–conducting substrate, for the F–G– $6\sqrt{3}$ C/SiC and F–G/ H–SiC samples; this can be achieved by removing fluorine atoms and recovering the metallic graphene π bands, a process that occurs at much higher radiation doses.

2. High intensity irradiation

To investigate the removal of the fluorine atoms, the samples were exposed to a $\sim 100 \,\mu\text{m}^2$ high intensity photon beam for several hours. XPS spectra of the C1s and F 1s peaks were then obtained as a function of sample position across the photon exposed regions. An example measurement, from a F–6 $\sqrt{3}$ C/SiC sample, is presented in Fig. 7 with the C 1s line shown in A and B and the fitted F1s amplitude presented in C. The irradiated regions (red dashed lines) are characterized by the F 1s intensity minima and a distinct change in the C1s spectra. An example C1s spectra from a fluorine depleted region is shown as the inset to Fig. 7 A. This peak has the characteristic shape of a $6\sqrt{3}$ C–SiC C1s spectra, and the fitted components as described by Emtsev et al.²⁴ accurately describe this peak.

The ground state electronic structure, with a band gap of ~ 6.2 eV, can thus be modified to give a semi-conducting (band gap of ~ 2.5 eV) region or a metallic graphene region by photon irradiation. Currently electronic circuits are patterned using lithographic techniques at the nanometre scale, making this material technologically important. It is also expected that the use of different functional groups, in place of the F, will produce different band gaps between localized energy levels. This is already evidenced by the case of $6\sqrt{3}$ C–SiC where these bands not only have a much smaller separation (~ 1 eV) but the upper one is shifted below the Fermi level. Calculations also show that replacing F with H should result in a reduced band gap between these localized bands (~ 1 eV), but also, and more importantly, the levels should be spin polarized producing a half metal²⁰.

IV. CONCLUSION

The electronic, chemical and physical structure of half fluorinated graphene on three different substrate interfaces has been determined. Fluorine is bonded to one sub–lattice of the graphene, which results in σ bands, bonding π bands and non–bonding localized π states. Fermi level pinning acts to align the band gaps of the fluorinated graphene and SiC and sets the Fermi level within this gap while relative shifts in the valence and core levels are attributed to partial metallization and hybridization of localized π orbitals in the graphene layer. These mechanisms are usually associated with organic electronic films, and the localized π bonding states in the current samples are very similar to the HOMO and LUMO levels of such films. Both the energies of the occu-

pied and unoccupied states have been measured, and the results show that σ bonds are relatively unchanged by the fluorination, while the bonding π bands show significantly less dispersion than un-fluorinated graphene, as is predicted by calculations. The same mechanisms, usually associated with organic electronic films, explain the electronic structure of the similar $6\sqrt{3}$ C–SiC, where two thirds of one graphene sub–lattice bond to the substrate.

The ground state electronic structure, with a band gap of ~ 6.2 eV, is modified to give an organic semi-conducting (band gap of ~ 2.5 eV) region or a metallic graphene region by photon irradiation. Using this process patterning by standard lithographic techniques is possible. It is expected that the use of different functional groups, in place of the F, will produce different band gaps between localized energy levels. The half-fluorinated samples are therefore represent the first in an important family of graphene based materials.

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